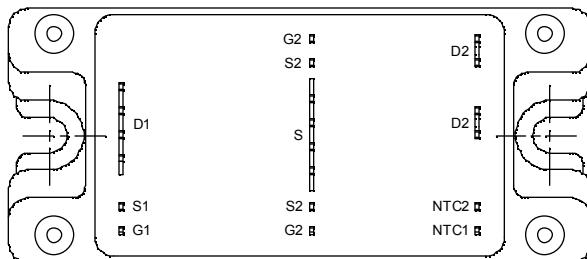
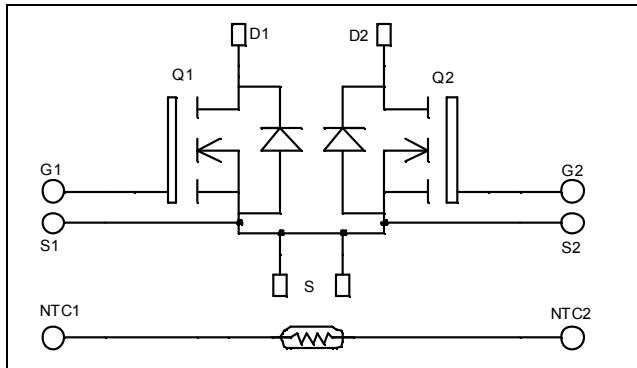


**Dual Common Source  
MOSFET Power Module**

**V<sub>DSS</sub> = 1200V**  
**R<sub>DSon</sub> = 290mΩ typ @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 34A @ T<sub>c</sub> = 25°C**


**Application**

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

**Features**

- Power MOS 7® MOSFETs
  - Low R<sub>DSon</sub>
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration

**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

**Absolute maximum ratings**

Symbol	Parameter	Max ratings	Unit
V <sub>DSS</sub>	Drain - Source Breakdown Voltage	1200	V
I <sub>D</sub>	Continuous Drain Current	T <sub>c</sub> = 25°C T <sub>c</sub> = 80°C	34 25
I <sub>DM</sub>	Pulsed Drain current		
V <sub>GS</sub>	Gate - Source Voltage	±30	V
R <sub>DSon</sub>	Drain - Source ON Resistance	348	mΩ
P <sub>D</sub>	Maximum Power Dissipation	T <sub>c</sub> = 25°C	780
I <sub>AR</sub>	Avalanche current (repetitive and non repetitive)		
E <sub>AR</sub>	Repetitive Avalanche Energy	22	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	50	mJ
		3000	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$ , $V_{DS} = 1200\text{V}$	$T_j = 25^\circ\text{C}$			350	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $V_{DS} = 1000\text{V}$	$T_j = 125^\circ\text{C}$			1500	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$ , $I_D = 17\text{A}$			290	348	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 5\text{mA}$		3		5	$\text{V}$
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{ V}$ , $V_{DS} = 0\text{V}$				$\pm 150$	$\text{nA}$

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			10.3		$\text{nF}$
$C_{oss}$	Output Capacitance				1.54		
$C_{rss}$	Reverse Transfer Capacitance				0.26		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 600\text{V}$ $I_D = 34\text{A}$			374		$\text{nC}$
$Q_{gs}$	Gate – Source Charge				48		
$Q_{gd}$	Gate – Drain Charge				240		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ $V_{Bus} = 800\text{V}$ $I_D = 34\text{A}$ $R_G = 2.5\Omega$			20		$\text{ns}$
$T_r$	Rise Time				15		
$T_{d(off)}$	Turn-off Delay Time				160		
$T_f$	Fall Time				45		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 800\text{V}$ $I_D = 34\text{A}$ , $R_G = 2.5\Omega$			1980		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				1371		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 800\text{V}$ $I_D = 34\text{A}$ , $R_G = 2.5\Omega$			3131		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				1714		

**Source - Drain diode ratings and characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_S$	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$			34	$\text{A}$
			$T_c = 80^\circ\text{C}$			25	
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{V}$ , $I_S = - 34\text{A}$				1.3	$\text{V}$
$dv/dt$	Peak Diode Recovery ①					10	$\text{V/ns}$
$t_{rr}$	Reverse Recovery Time	$I_S = - 34\text{A}$ ; $V_R = 600\text{V}$ $dI_S/dt = 200\text{A}/\mu\text{s}$			1291		$\text{ns}$
$Q_{rr}$	Reverse Recovery Charge				58		$\mu\text{C}$

 ①  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

 $I_S \leq - 34\text{A}$     $di/dt \leq 700\text{A}/\mu\text{s}$     $V_R \leq V_{DSS}$     $T_j \leq 150^\circ\text{C}$



### Thermal and package characteristics

Symbol    Characteristic

Min    Typ    Max    Unit

R <sub>thJC</sub>	Junction to Case Thermal Resistance			0.16	°C/W	
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t = 1 min, I isol<1mA, 50/60Hz	2500			V	
T <sub>J</sub>	Operating junction temperature range	-40		150	°C	
T <sub>STG</sub>	Storage Temperature Range	-40		125		
T <sub>C</sub>	Operating Case Temperature	-40		100		
Torque	Mounting torque	To Heatsink	M5	2.5	4.7	N.m
Wt	Package Weight			160	g	

**Temperature sensor NTC** (see application note APT0406 on www.microsemi.com for more information).

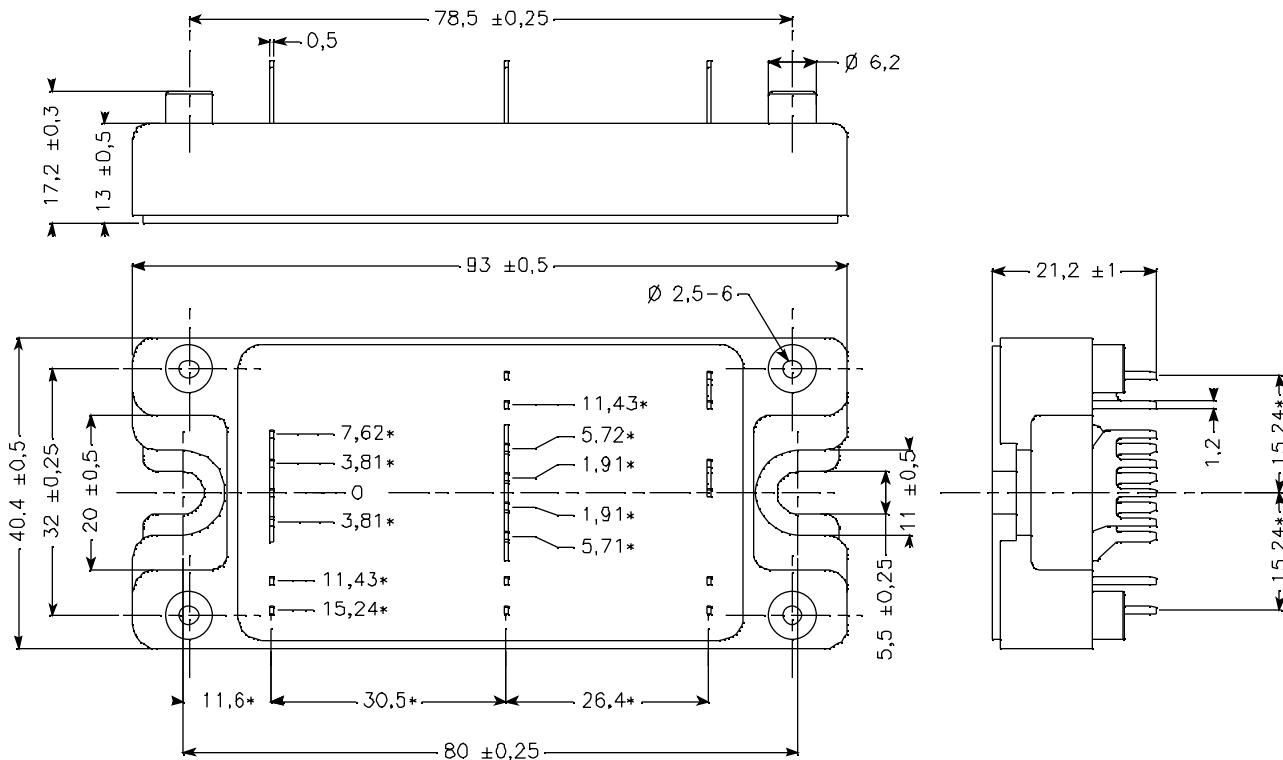
Symbol    Characteristic

Min    Typ    Max    Unit

R <sub>25</sub>	Resistance @ 25°C		50		kΩ
B <sub>25/85</sub>	T <sub>25</sub> = 298.15 K		3952		K

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad \begin{aligned} T: & \text{ Thermistor temperature} \\ R_T: & \text{ Thermistor value at } T \end{aligned}$$

### SP4 Package outline (dimensions in mm)

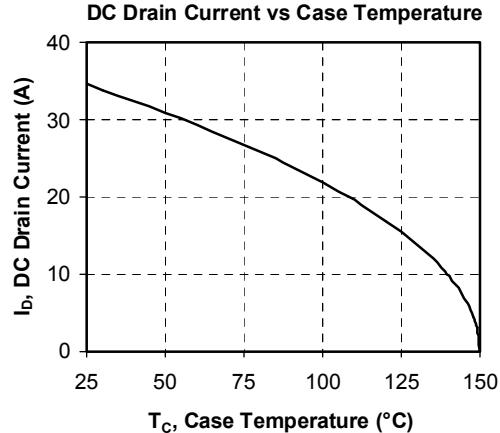
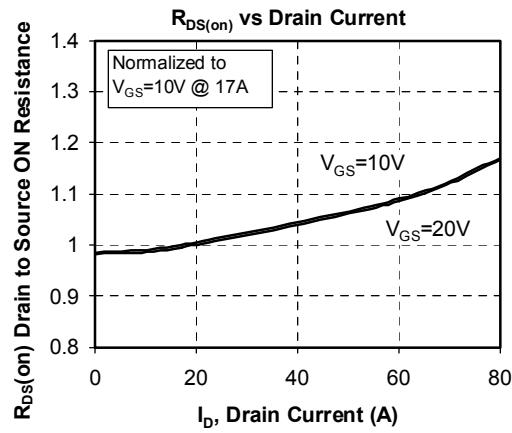
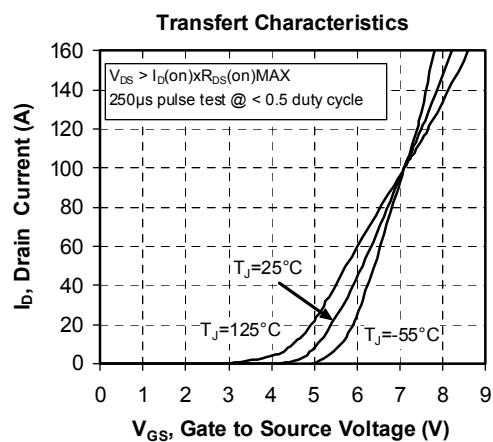
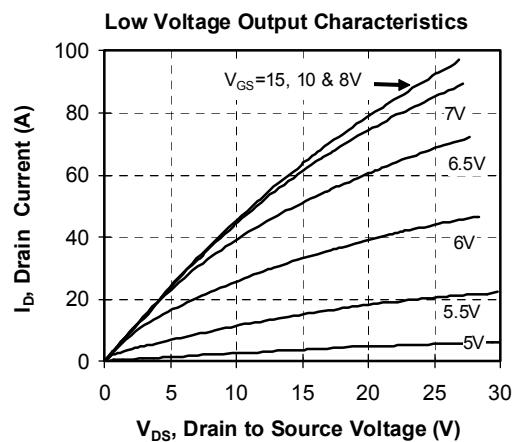
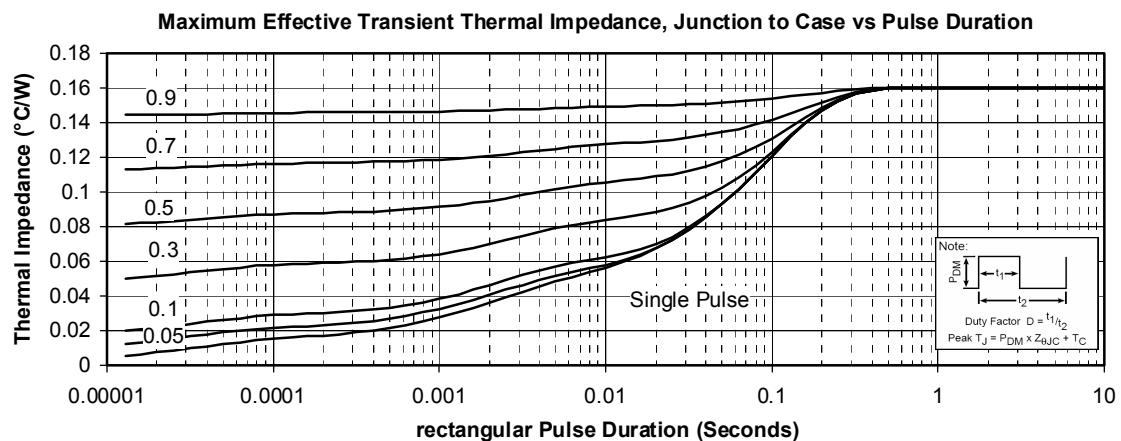


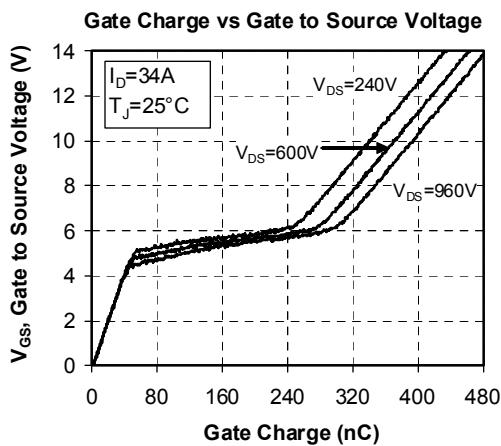
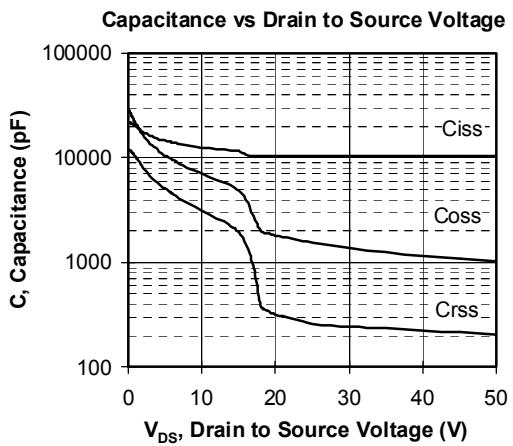
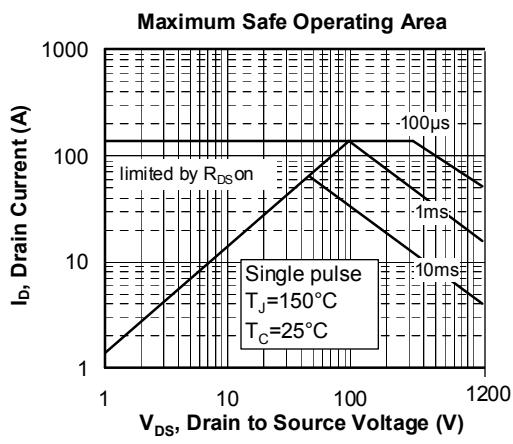
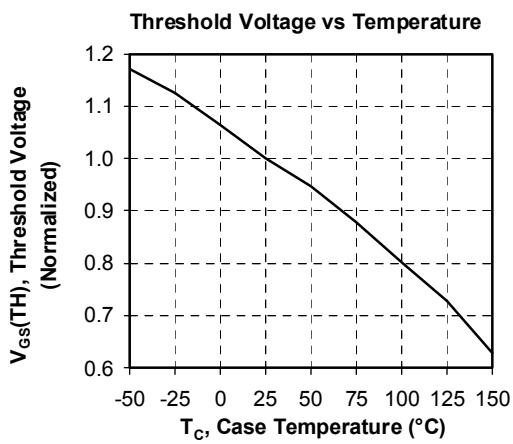
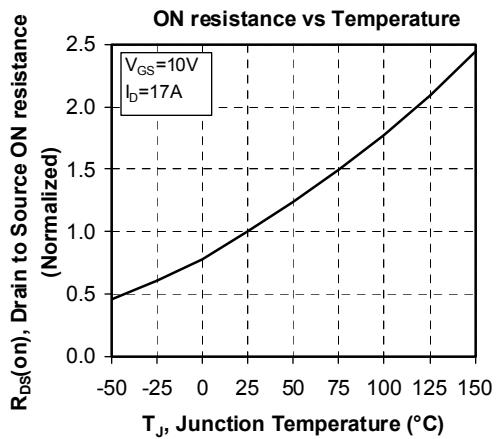
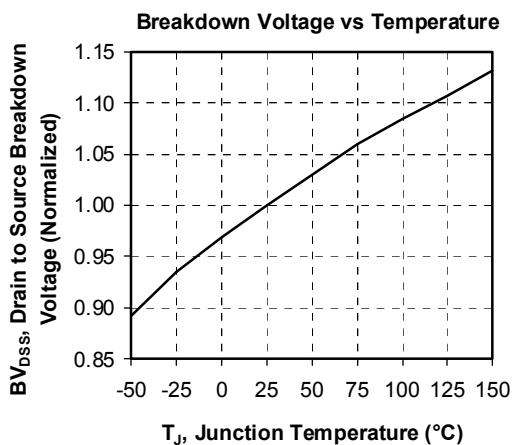
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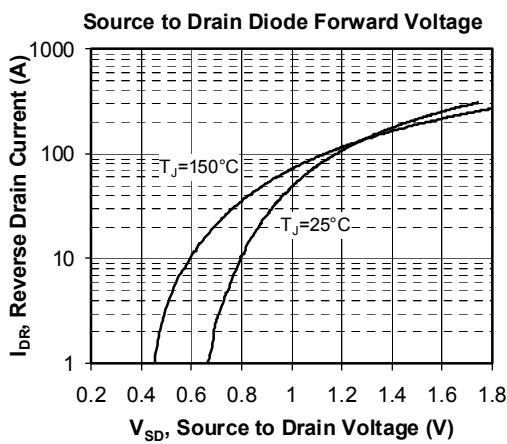
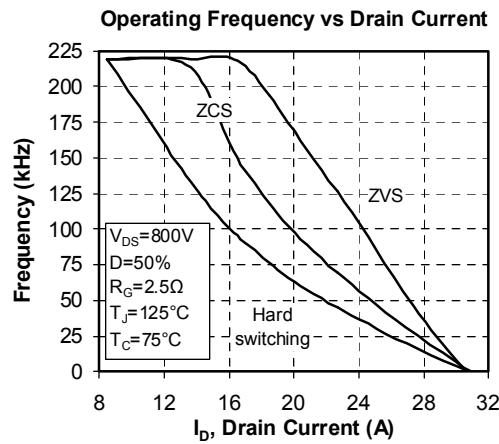
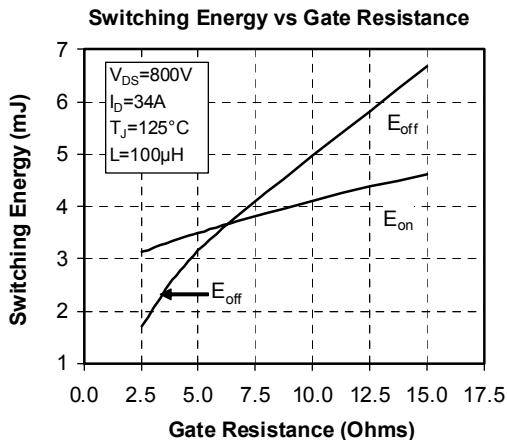
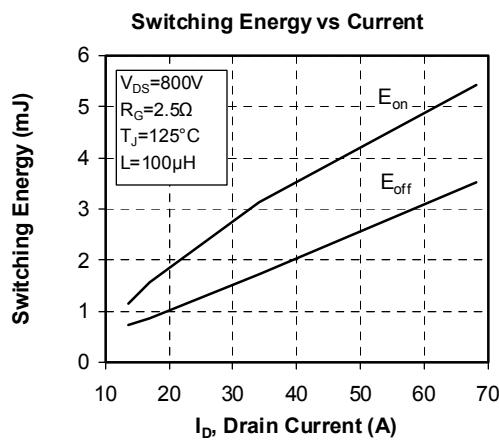
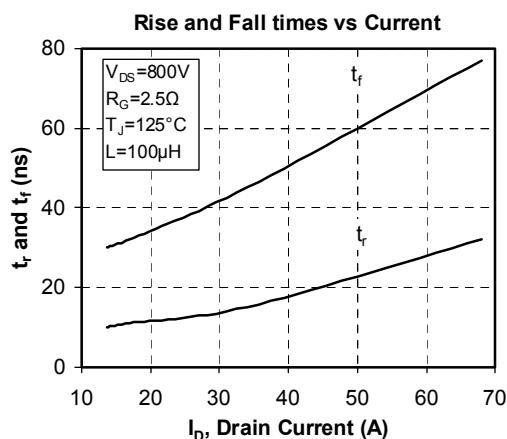
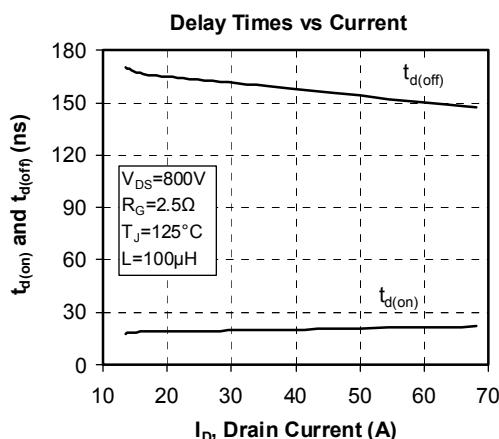
See application note APT0501 - Mounting Instructions for SP4 Power Modules on [www.microsemi.com](http://www.microsemi.com)



### Typical Performance Curve







Microsemi reserves the right to change, without notice, the specifications and information contained herein

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